

IN THE CLAIMS: ✓

Please amend Claim 39, as follows:

39. (Amended) Method of mounting an interconnection element to a terminal of an electronic component, comprising:

attaching an elongate element of a first material to a terminal of an electronic component;

shaping the elongate element with a shaping tool; and

overcoating the elongate element with a second material which has a higher yield strength than the first material, in an amount sufficient for imparting a desired resiliency to the interconnection element, whereby the interconnection element after the overcoating step is substantially stiffer than the elongate element prior to the overcoating step.